# RDG Radiate Group Radiation

# **Graphene-Enabled Silicon-Integrated Radiation Detector for Low Penetrating Particles**





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### Introduction

- Motivation
- Detector Concept
- Simulation
- Measurements
- Prospects





### **Motivation**

- We wanted to create a "junction" with a minimum dead layer.
- We are interested in detecting low-penetrating particles such as ions, electrons, protrons and "Soft X-rays"
- "Soft X-rays" can be used to study biological samples.
- Specifically we want to build a detector capable of studying X-rays with an energy in the so-called "water window", between the Carbon and Oxygen edges (282 eV to 533 eV – Carbon and Oxygen being present in all biological samples).





### **Detector Concept – Graphene-on-Insulator-on-Silicon (GIS)**



- Absorption layer (the 35um Si) and bulk Si (the 300um Si)
- Graphene placed on top of thin dielectric (3nm) in electrical contact with metal.
- Reverse bias applied to metal with ohmic contact to the highly-doped N región.
- Detector depletes under the Nelectrode and under all regions of the detector with Graphene on top.
- An inversión layer is present at the interface of Oxide/Silicon
- Dead región is defined by the thickness of the oxide. -> 3nm







### **TCAD Simulation**



- TCAD model developed using Sentaurus TCAD.
- Graphene model doesn't exist, instead a modified model of polysilicon used.
- Image shows Electric field lines.
- Charge carrier shows upward movement within the bulk silicon.
- Bending of the lines at the Surface, below the dielectric layer towards the bias ring(Highly doped N region).







### Simulation



- **Simulation** shows that the risetime of the signal is dependant on the initial charge injection position.
- This is due to the difference in time required for the charge to travel along the surface of the detector.
- The **risetime** is proportional to both the distance to the collection electrode and the resistance of the device below the surface.







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### TCT









### TCT



- **Charge** as function of injection position is uniform.
- Collection time and risetime can be different but all charge is collected.

- Measurements show that the **risetime** of the signal is dependent on the initial charge injection position.
- As expected from the simulation



Risetime







### **Photoresponsivity Setup**

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- Monochromator system used to modify the wavelength of light (200-800nm).
- The detector was biased to a **fixed voltage** and a sweep of wavelength performed.
- The photocurrent was measured as a function of wavelength.
- The responsivity was then calculated based on measurements of a **calibrated** HPK diode.
- All measurements performed in the Detector Development Lab at the University of Glasgow with the help of Dr Dima Maneuski. (Dima.Maneuski@glasgow.ac.uk)







## Photoresponsivity



- Photo response of fabricated detectors show a variety of responses.
- To note the **max responsivity** of a silicon detector at 200nm is 0.17A/W
- The HPK reference diode shows good sensitivity at the full wavelength range.
- The devices with graphene show a superior response at wavelengths below 230nm.
- It is thought that the graphene must undergo gating (which is voltage dependant) in order to collect light at these wavelengths.

https://www.sciencedirect.com/scienc e/article/abs/pii/S1748013210001623? via%3Dihub

- Main feature is that the devices are active at the full wavelength range.
- Penetration depth of light of 200nm is approx 4nm.





### **Prospects – AC-LGAD coupled with GIS**







### Conclusions

- A device with a minimum dead area has been presented, which has been made utilizing the, almost, transparent nature of graphene.
- The device has a uniform charge collection across the entire area but the shape of the signal varies depending on the point of charge interaction.
- An LGAD device with this window could be produced for imaging of soft X-rays and DUV light.
- Next stage is in production. The first LGAD device with this transparent window will be produced at CNM this year using the AC-LGAD technology.











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# Thanks for your attention!







### Backup





### **Simulation Model**

Parameters	Description	Value
$E_G(eV)$	Bandgap	0
χ	Permittivity	25
$\mu_n(cm^2/Vs)$	Electron mobility	10,000
$\mu_p(cm^2/Vs)$	Hole mobility	10,000
X(kg/mole)	Affinity	4.248
Vsat	Electron saturation velocity	$4x10^{7}$

TABLE I. Material parameters of Graphene used for model<sup>16</sup>.

<sup>16</sup> K. J. Singh, T. Thingujam, and M. Kumar, "Tcad based modeling and simulation of graphene nanostructured fet (gfet) for high frequency performance," ADBU Journal of Engineering Technology (AJET) 6, 49 (2017).







### **Si Detectors**

W2 Active bulk 35 μm JTE P shallow junction S1 and S3 with metal on the Surface S2 and S4 without metal

#### W3 Active bulk 35 μm JTE NO P shallow junction – Graphene Deposited S1 and S3 with metal on the Surface S2 and S4 without metal

### Graphene Layer







### **Measurements of EQE- ShallowImplant**

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### **Measurements of EQE– NoImplant with Graphene**







### **Measurements of EQE– Comparison**









### Setup



Output from Monochromator

Detector

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### **Absorption Depth in Silicon**







### **Absorption depth in silicon**

